

Global Epoxy Die Bonding Adhesive Market 2026 by Manufacturers, Regions, Type and Application, Forecast to 2032

<https://marketpublishers.com/r/GA664146ABE9EN.html>

Date: August 2026

Pages: 119

Price: US\$ 3,480.00 (Single User License)

ID: GA664146ABE9EN

Abstracts

According to our (Global Info Research) latest study, the global Epoxy Die Bonding Adhesive market size was valued at US\$ 1505 million in 2025 and is forecast to a readjusted size of US\$ 2562 million by 2032 with a CAGR of 7.7% during review period.

In 2025, global production of epoxy die bonding adhesive is approximately 37,500 metric tons, with a global average market price of around \$39,000 per metric ton. The total global production capacity for epoxy die bonding adhesive in 2025 is approximately 67,000 metric tons. The average gross profit margin for the industry stands at 37%. Epoxy Die Bonding Adhesive is a functional adhesive material based on epoxy resin, used in semiconductor packaging processes to bond semiconductor chips with substrates, lead frames, or packaging carriers. These adhesives typically form highly cross-linked structures through thermal curing, providing excellent adhesion strength, electrical insulation, dimensional stability, and chemical resistance. They are widely used in LED packaging, power devices, integrated circuit packaging, and electronic component manufacturing. By incorporating conductive or thermally conductive fillers such as silver particles, aluminum oxide, and boron nitride, epoxy die bonding adhesives can achieve enhanced electrical conductivity, heat dissipation, and high-reliability packaging performance. With the development of Mini LED, automotive electronics, power semiconductors, and advanced packaging technologies, demand for low-stress, high-thermal-conductivity, and high-reliability epoxy die bonding adhesives continues to increase.

The upstream segment of the epoxy die bonding adhesive industry mainly includes suppliers of epoxy resins, curing agents, accelerators, functional fillers, and specialty chemical additives. Epoxy resin is the key raw material determining the fundamental

performance of the adhesive, with its purity, molecular structure, and thermal stability directly affecting bonding strength and reliability. Common functional fillers include silver particles, aluminum oxide, aluminum nitride, boron nitride, and silica, which improve electrical conductivity, thermal conductivity, and mechanical stability. Upstream suppliers require capabilities in high-purity chemical synthesis, nano-filler processing, and formulation optimization. High-end epoxy die bonding adhesives require strict material consistency and impurity control, with supply concentrated among global chemical companies and specialized electronic material manufacturers. The midstream segment of the epoxy die bonding adhesive industry includes adhesive formulation design, material modification, manufacturing, and quality testing companies. Midstream manufacturers optimize epoxy systems, curing mechanisms, and filler ratios to achieve application-specific properties such as low-temperature curing, high thermal conductivity, low shrinkage, low stress, and fast curing. Products are typically supplied in liquid adhesive, paste, or preformed film formats and customized according to requirements from LED packaging, semiconductor packaging, and power device applications. Due to strict reliability requirements in chip packaging, midstream companies must establish technical barriers through long-term customer validation, reliability testing, and process integration. International companies currently dominate high-end markets, while Asian manufacturers are accelerating localization and domestic substitution strategies. The downstream applications of epoxy die bonding adhesives mainly include LED packaging, semiconductor devices, power electronics, automotive electronics, consumer electronics, and industrial electronic equipment. Traditional LED packaging represents a mature application area, where these adhesives are mainly used for die attachment and structural fixation. With the growth of electric vehicles, intelligent driving, and high-power electronic devices, demand for highly reliable die bonding adhesives in automotive LEDs and power semiconductors continues to increase. In addition, the development of Mini LED, Micro LED, and advanced packaging technologies is driving epoxy die bonding adhesives toward lower stress, higher thermal conductivity, and precision processing capabilities. In the future, downstream demand will continue expanding around high-performance electronic devices, miniaturized packaging, and high-reliability applications.

The continuous expansion of the semiconductor industry and increasing performance requirements of electronic devices are major drivers for the growth of Epoxy Die Bonding Adhesive. As a critical material in chip attachment and semiconductor packaging processes, epoxy die bonding adhesive benefits from the growth of integrated circuits, LEDs, power devices, and electronic components. The rapid development of smartphones, 5G communication, artificial intelligence computing, automotive electronics, and IoT devices has increased demand for miniaturized, highly

integrated, and reliable electronic products, encouraging adhesive technologies to improve toward lower stress, stronger adhesion, and higher durability.

The growth of electric vehicles, electrification, and intelligent driving technologies is creating new opportunities for high-performance epoxy die bonding adhesives. Power semiconductor devices such as IGBTs, MOSFETs, and SiC devices require packaging materials with excellent thermal conductivity, high-temperature resistance, and long-term reliability. By incorporating functional fillers such as silver particles, aluminum oxide, and aluminum nitride, advanced epoxy die bonding adhesives can provide enhanced electrical, thermal, and mechanical performance, supporting demanding power electronics applications.

With the development of Mini LED, Micro LED, advanced semiconductor packaging, and chiplet technologies, die bonding materials are evolving toward higher precision, lower defect rates, and improved reliability. Future epoxy die bonding adhesives will require lower thermal expansion, reduced curing shrinkage, enhanced thermal management, and more precise dispensing performance. Low-stress epoxy systems, high-thermal-conductivity formulations, and fast-curing technologies are expected to become key development directions.

This report is a detailed and comprehensive analysis for global Epoxy Die Bonding Adhesive market. Both quantitative and qualitative analyses are presented by manufacturers, by region & country, by Type and by Application. As the market is constantly changing, this report explores the competition, supply and demand trends, as well as key factors that contribute to its changing demands across many markets. Company profiles and product examples of selected competitors, along with market share estimates of some of the selected leaders for the year 2025, are provided.

Key Features:

Global Epoxy Die Bonding Adhesive market size and forecasts, in consumption value (\$ Million), sales quantity (Tons), and average selling prices (US\$/Ton), 2021-2032

Global Epoxy Die Bonding Adhesive market size and forecasts by region and country, in consumption value (\$ Million), sales quantity (Tons), and average selling prices (US\$/Ton), 2021-2032

Global Epoxy Die Bonding Adhesive market size and forecasts, by Type and by Application, in consumption value (\$ Million), sales quantity (Tons), and average selling

prices (US\$/Ton), 2021-2032

Global Epoxy Die Bonding Adhesive market shares of main players, shipments in revenue (\$ Million), sales quantity (Tons), and ASP (US\$/Ton), 2021-2026

The Primary Objectives in This Report Are:

To determine the size of the total market opportunity of global and key countries

To assess the growth potential for Epoxy Die Bonding Adhesive

To forecast future growth in each product and end-use market

To assess competitive factors affecting the marketplace

This report profiles key players in the global Epoxy Die Bonding Adhesive market based on the following parameters - company overview, sales quantity, revenue, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include Henkel, Dow Chemical, Shin-Etsu Chemical, Darbond, Earlysun Technology, Kmt Technology, Niche-Tech, Huitian Adhesive, NAMICS Corporation, Panacol, etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

Market Segmentation

Epoxy Die Bonding Adhesive market is split by Type and by Application. For the period 2021-2032, the growth among segments provides accurate calculations and forecasts for consumption value by Type, and by Application in terms of volume and value. This analysis can help you expand your business by targeting qualified niche markets.

Market segment by Type

Non-Conductive Epoxy Die Bonding Adhesive

Electrically Conductive Epoxy Die Bonding Adhesive

Anisotropic Conductive Adhesive

Market segment by Thermal Conductivity Classification

Standard Thermal Epoxy Adhesive

High Thermal Conductivity Epoxy Adhesive

Ultra-high Thermal Conductive Epoxy Adhesive

Market segment by Curing Method

Thermal Curing Epoxy Adhesive

Fast-curing Epoxy Adhesive

Low-temperature Curing Epoxy Adhesive

Market segment by Form

Liquid Epoxy Adhesive

Epoxy Paste Adhesive

Epoxy Adhesive Film

Market segment by Application

LED Display and Backlight

Automotive LED

Consumer Electronics LED

Others

Major players covered

Henkel

Dow Chemical

Shin-Etsu Chemical

Darbond

Earlysun Technology

Kmt Technology

Niche-Tech

Huitian Adhesive

NAMICS Corporation

Panacol

Hitachi Chemical(Resonac)

Meridian Adhesive

DELO Industrial Adhesives

Dymax Corporation

Market segment by region, regional analysis covers

North America (United States, Canada, and Mexico)

Europe (Germany, France, United Kingdom, Russia, Italy, and Rest of Europe)

Asia-Pacific (China, Japan, Korea, India, Southeast Asia, and Australia)

South America (Brazil, Argentina, Colombia, and Rest of South America)

Middle East & Africa (Saudi Arabia, UAE, Egypt, South Africa, and Rest of Middle East & Africa)

The content of the study subjects, includes a total of 15 chapters:

Chapter 1, to describe Epoxy Die Bonding Adhesive product scope, market overview, market estimation caveats and base year.

Chapter 2, to profile the top manufacturers of Epoxy Die Bonding Adhesive, with price, sales quantity, revenue, and global market share of Epoxy Die Bonding Adhesive from 2021 to 2026.

Chapter 3, the Epoxy Die Bonding Adhesive competitive situation, sales quantity, revenue, and global market share of top manufacturers are analyzed emphatically by landscape contrast.

Chapter 4, the Epoxy Die Bonding Adhesive breakdown data are shown at the regional level, to show the sales quantity, consumption value, and growth by regions, from 2021 to 2032.

Chapter 5 and 6, to segment the sales by Type and by Application, with sales market share and growth rate by Type, by Application, from 2021 to 2032.

Chapter 7, 8, 9, 10 and 11, to break the sales data at the country level, with sales quantity, consumption value, and market share for key countries in the world, from 2021 to 2026. and Epoxy Die Bonding Adhesive market forecast, by regions, by Type, and by Application, with sales and revenue, from 2027 to 2032.

Chapter 12, market dynamics, drivers, restraints, trends, and Porters Five Forces analysis.

Chapter 13, the key raw materials and key suppliers, and industry chain of Epoxy Die Bonding Adhesive.

Chapter 14 and 15, to describe Epoxy Die Bonding Adhesive sales channel, distributors, customers, research findings and conclusion.

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